

STTH102-Y

Automotive high efficiency ultrafast diode

Features

- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature
- ECOPACK[®]2 compliant component
- AEC-Q101 qualified

Description

The STTH102-Y, which is using ST's new 200 V planar technology, is specially suited for switching mode base drive and transistor circuits. The device is also intended for use as a free wheeling diode in power supplies and other power switching applications for automotive.

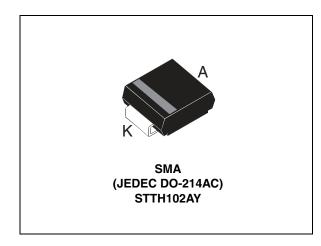


Table 1. Device summary

Symbol	Value
I _{F(AV)}	1 A
V_{RRM}	200 V
T _j (max)	175 °C
V _F (max)	0.78 V
t _{rr} (max)	20 ns

Characteristics STTH102-Y

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Table 2. Absolute rating (limiting values)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	200	V	
I _{F(AV)}	Average forward current $T_L = 148 ^{\circ}\text{C} \delta = 0.5$		1	Α
I _{FSM}	Surge non repetitive forward current	40	Α	
T _{stg}	Storage temperature range	-65 to + 175	°C	
T _j	Operating junction temperature range	-40 to +175	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to lead	30	°C/W

Table 4. Static Electrical Characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _B ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}			1	μA
'R '	IR CALLETTE	T _j = 125 °C	VR = VRRM		1	25	μΛ
	$V_F^{(2)}$ Forward voltage drop	T _i = 25 °C	I _F = 700 mA			0.90	
V _F ⁽²⁾		1 _j = 25 C	I _F = 1 A			0.97	V
			I _F = 1 A		0.68	0.78	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation: $P = 0.65 \times I_{F(AV)} + 0.130 I_{F^2(RMS)}$

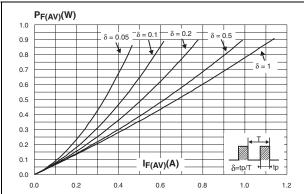
Table 5. Dynamic electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I _F = 0.5 A I _{rr} = 0.25 A I _R = 1 A		12	20	ns
t _{fr}	Forward recovery time	T _j = 25 °C	$I_F = 1 \text{ A } dI_F/dt = 50 \text{ A/ms}$ $V_{FR} = 1.1 \text{ x } V_F \text{max}$		50		ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	$I_F = 1 A dI_F/dt = 50 A/ms$		1.8		٧

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

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Figure 1. Average forward power dissipation Figure 2. Average forward current versus awbient temperature (δ = 0.5)



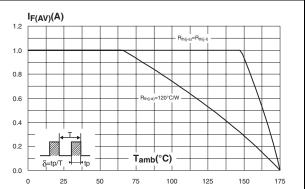
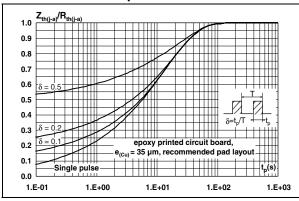


Figure 3. Relative variation of thermal impedance junction to ambient versus pulse duration

Figure 4. Forward voltage drop versus forward current



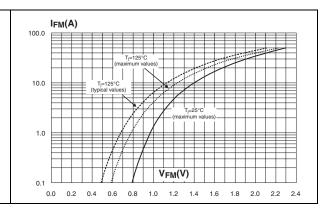
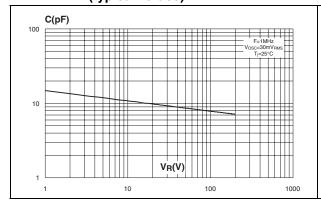
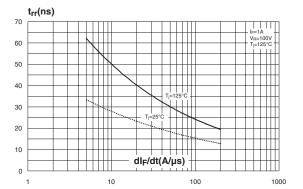


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

Figure 6. Reverse recovery time versus dI_F/dt (90% confidence)





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Figure 7. Peak recovery current versus dl_F/dt Figure 8. Reverse recovery charges versus dl_F/dt (90% confidence)

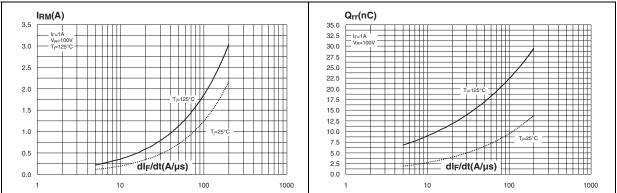
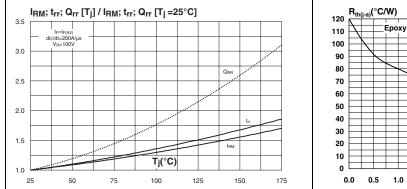
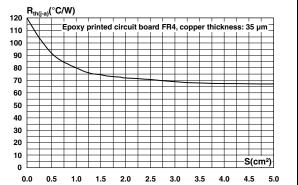


Figure 9. Relative variations of dynamic parameters versus junction temperature

Figure 10. Thermal resistance junction to ambient versus copper surface under each lead





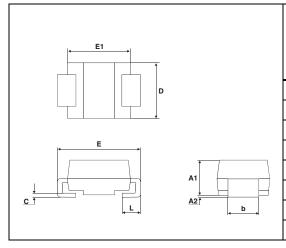
4/7 Doc ID 17982 Rev 1

2 Package information

- Epoxy meets UL94 V0
- Lead-free packages

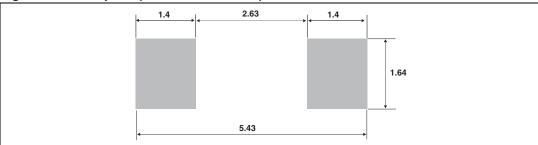
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 6. SMA dimensions



		Dimensions			
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
A1	1.90	2.45	0.075	0.094	
A2	0.05	0.20	0.002	0.008	
b	1.25	1.65	0.049	0.065	
С	0.15	0.40	0.006	0.016	
D	2.25	2.90	0.089	0.114	
Е	4.80	5.35	0.189	0.211	
E1	3.95	4.60	0.156	0.181	
L	0.75	1.50	0.030	0.059	

Figure 11. Footprint (dimensions in mm)



Ordering information STTH102-Y

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH102AY	U12Y	SMA	0.068 g	5000	Tape and reel

4 Revision history

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Table 8. Revision history

Date	Revision	Changes	
07-Nov-2011	1	Initial release.	

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